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2N7002L, 2V7002L

Small Signal MOSFET

60 V, 115 mA, N-Channel SOT-23



ON Semiconductor®

<http://onsemi.com>

Features

- 2V Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable (2V7002L)
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

MAXIMUM RATINGS

| Rating | Symbol | Value | Unit |
|--|-----------------------|------------------------------------|------------|
| Drain-Source Voltage | V_{DS} | 60 | Vdc |
| Drain-Gate Voltage ($R_{GS} = 1.0 \text{ M}\Omega$) | V_{DGR} | 60 | Vdc |
| Drain Current - Continuous $T_C = 25^\circ\text{C}$ (Note 1) - Pulsed (Note 2) $T_C = 100^\circ\text{C}$ (Note 1) | I_D I_{DM} | ± 115 ± 75 ± 800 | mAdc |
| Gate-Source Voltage - Continuous - Non-repetitive ($t_p \leq 50 \mu\text{s}$) | V_{GS} V_{GSM} | ± 20 ± 40 | Vdc Vpk |

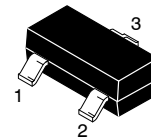
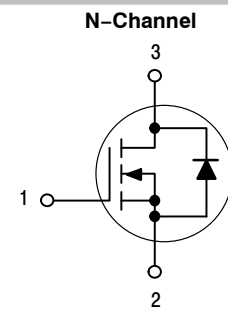
THERMAL CHARACTERISTICS

| Characteristic | Symbol | Max | Unit |
|---|-----------------|----------------|---|
| Total Device Dissipation FR-5 Board (Note 3) $T_A = 25^\circ\text{C}$ Derate above 25°C | P_D | 225 | mW |
| Thermal Resistance, Junction-to-Ambient | $R_{\theta JA}$ | 1.8 556 | $\text{mW}/^\circ\text{C}$ $^\circ\text{C}/\text{W}$ |
| Total Device Dissipation (Note 4) Alumina Substrate, $T_A = 25^\circ\text{C}$ Derate above 25°C | P_D | 300 | mW |
| Thermal Resistance, Junction-to-Ambient | $R_{\theta JA}$ | 2.4 417 | $\text{mW}/^\circ\text{C}$ $^\circ\text{C}/\text{W}$ |
| Junction and Storage Temperature | T_J, T_{stg} | -55 to +150 | $^\circ\text{C}$ |

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. The Power Dissipation of the package may result in a lower continuous drain current.
2. Pulse Test: Pulse Width $\leq 300 \mu\text{s}$, Duty Cycle $\leq 2.0\%$.
3. FR-5 = $1.0 \times 0.75 \times 0.062$ in.
4. Alumina = $0.4 \times 0.3 \times 0.025$ in 99.5% alumina.

| $V_{(BR)DSS}$ | $R_{DS(on)}$ MAX | I_D MAX |
|---------------|---|-----------|
| 60 V | $7.5 \Omega @ 10 \text{ V}, 500 \text{ mA}$ | 115 mA |



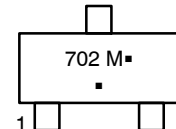
**SOT-23
CASE 318
STYLE 21**

702 = Device Code
M = Date Code*
▪ = Pb-Free Package

(Note: Microdot may be in either location)

*Date Code orientation and/or position may vary depending upon manufacturing location.

MARKING DIAGRAM



ORDERING INFORMATION

| Device | Package | Shipping† |
|-------------|---------------------|--------------------|
| 2N7002LT1G | SOT-23 | 3000 Tape & Reel |
| 2N7002LT3G | (Pb-Free) | 10,000 Tape & Reel |
| 2V7002LT1G | SOT-23 (Pb-Free) | 3000 Tape & Reel |
| 2V7002LT3G | | 10,000 Tape & Reel |
| 2N7002LT1H* | | 3000 Tape & Reel |

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

*Not for new design.

2N7002L, 2V7002L

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

| Characteristic | Symbol | Min | Typ | Max | Unit |
|--|----------------------|-----|-----|------|------|
| OFF CHARACTERISTICS | | | | | |
| Drain-Source Breakdown Voltage (V _{GS} = 0, I _D = 10 μAdc) | V _{(BR)DSS} | 60 | - | - | Vdc |
| Zero Gate Voltage Drain Current (V _{GS} = 0, V _{DS} = 60 Vdc) | I _{DSS} | - | - | 1.0 | μAdc |
| | | | | 500 | |
| Gate-Body Leakage Current, Forward (V _{GS} = 20 Vdc) | I _{GSSF} | - | - | 100 | nAdc |
| Gate-Body Leakage Current, Reverse (V _{GS} = -20 Vdc) | I _{GSSR} | - | - | -100 | nAdc |

ON CHARACTERISTICS (Note 5)

| | | | | | |
|---|---------------------|-----|---|----------------------------|------|
| Gate Threshold Voltage (V _{DS} = V _{GS} , I _D = 250 μAdc) | V _{GS(th)} | 1.0 | - | 2.5 | Vdc |
| On-State Drain Current (V _{DS} ≥ 2.0 V _{DS(on)} , V _{GS} = 10 Vdc) | I _{D(on)} | 500 | - | - | mA |
| Static Drain-Source On-State Voltage (V _{GS} = 10 Vdc, I _D = 500 mAdc) (V _{GS} = 5.0 Vdc, I _D = 50 mAdc) | V _{DS(on)} | - | - | 3.75 0.375 | Vdc |
| Static Drain-Source On-State Resistance (V _{GS} = 10 V, I _D = 500 mAdc) (V _{GS} = 5.0 Vdc, I _D = 50 mAdc) | r _{DS(on)} | - | - | 7.5 13.5 7.5 13.5 | Ohms |
| | | | | | |
| | | | | | |
| Forward Transconductance (V _{DS} ≥ 2.0 V _{DS(on)} , I _D = 200 mAdc) | g _{FS} | 80 | - | - | mS |

DYNAMIC CHARACTERISTICS

| | | | | | |
|--|------------------|---|---|-----|----|
| Input Capacitance (V _{DS} = 25 Vdc, V _{GS} = 0, f = 1.0 MHz) | C _{iss} | - | - | 50 | pF |
| Output Capacitance (V _{DS} = 25 Vdc, V _{GS} = 0, f = 1.0 MHz) | C _{oss} | - | - | 25 | pF |
| Reverse Transfer Capacitance (V _{DS} = 25 Vdc, V _{GS} = 0, f = 1.0 MHz) | C _{rss} | - | - | 5.0 | pF |

SWITCHING CHARACTERISTICS (Note 5)

| | | | | | | |
|---------------------|---|---------------------|---|---|----|----|
| Turn-On Delay Time | (V _{DD} = 25 Vdc, I _D ≅ 500 mAdc, R _G = 25 Ω, R _L = 50 Ω, V _{gen} = 10 V) | t _{d(on)} | - | - | 20 | ns |
| Turn-Off Delay Time | | t _{d(off)} | - | - | 40 | ns |

BODY-DRAIN DIODE RATINGS

| | | | | | |
|---|-----------------|---|---|------|------|
| Diode Forward On-Voltage (I _S = 11.5 mAdc, V _{GS} = 0 V) | V _{SD} | - | - | -1.5 | Vdc |
| Source Current Continuous (Body Diode) | I _S | - | - | -115 | mAdc |
| Source Current Pulsed | I _{SM} | - | - | -800 | mAdc |

5. Pulse Test: Pulse Width ≤ 300 μs, Duty Cycle ≤ 2.0%.

TYPICAL ELECTRICAL CHARACTERISTICS

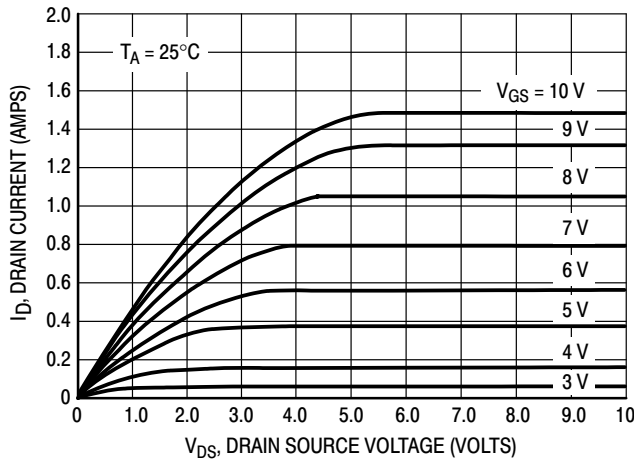


Figure 1. Ohmic Region

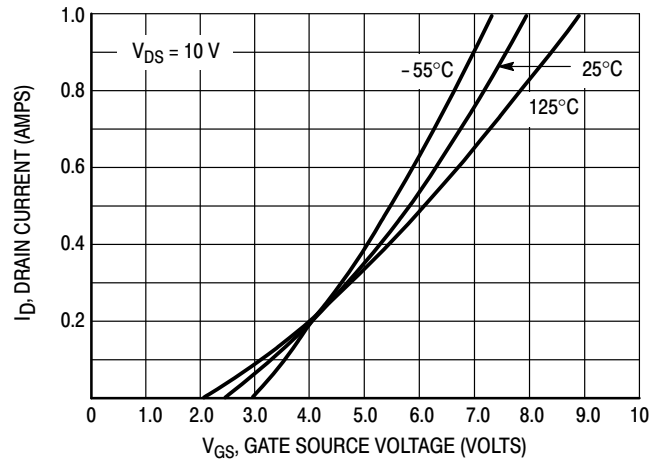


Figure 2. Transfer Characteristics

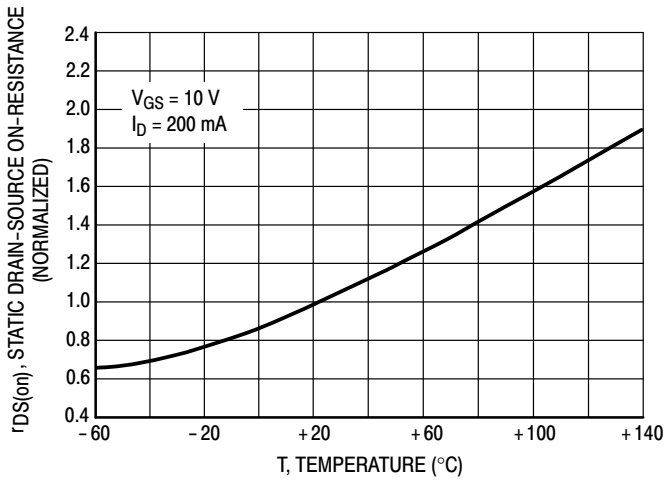


Figure 3. Temperature versus Static Drain-Source On-Resistance

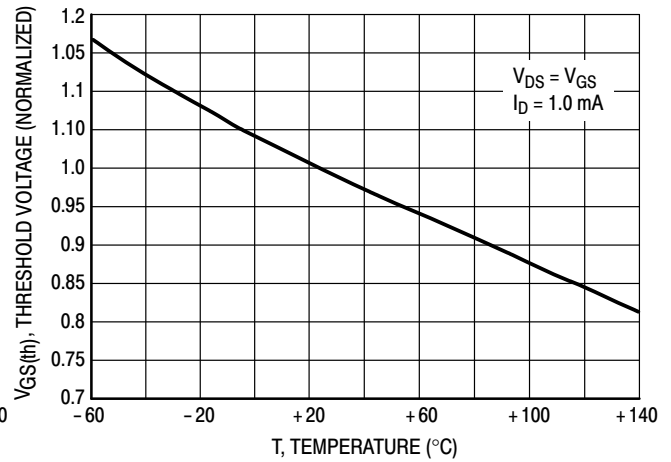
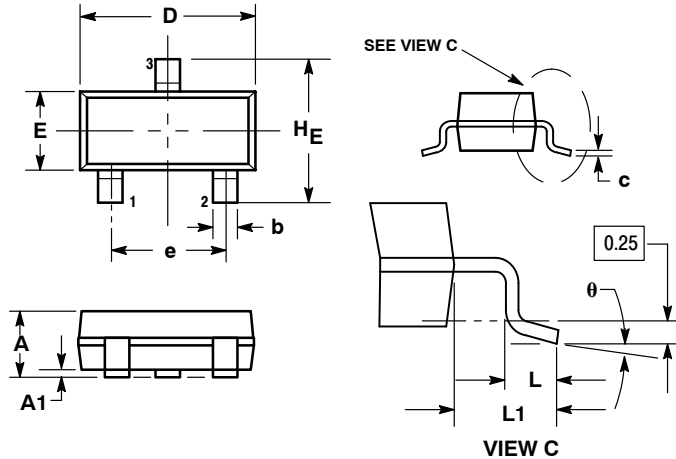


Figure 4. Temperature versus Gate Threshold Voltage

2N7002L, 2V7002L

PACKAGE DIMENSIONS

SOT-23 (TO-236)
CASE 318-08
ISSUE AP



NOTES:

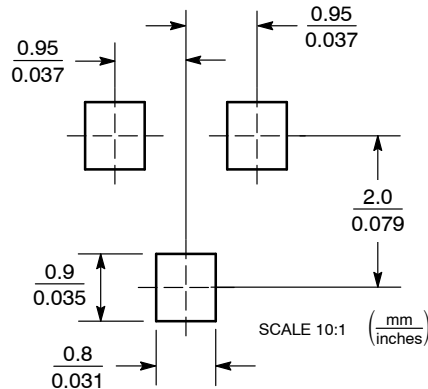
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL.
4. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS.


| DIM | MILLIMETERS | | | INCHES | | |
|-----|-------------|------|------|--------|-------|-------|
| | MIN | NOM | MAX | MIN | NOM | MAX |
| A | 0.89 | 1.00 | 1.11 | 0.035 | 0.040 | 0.044 |
| A1 | 0.01 | 0.06 | 0.10 | 0.001 | 0.002 | 0.004 |
| b | 0.37 | 0.44 | 0.50 | 0.015 | 0.018 | 0.020 |
| c | 0.09 | 0.13 | 0.18 | 0.003 | 0.005 | 0.007 |
| D | 2.80 | 2.90 | 3.04 | 0.110 | 0.114 | 0.120 |
| E | 1.20 | 1.30 | 1.40 | 0.047 | 0.051 | 0.055 |
| e | 1.78 | 1.90 | 2.04 | 0.070 | 0.075 | 0.081 |
| L | 0.10 | 0.20 | 0.30 | 0.004 | 0.008 | 0.012 |
| L1 | 0.35 | 0.54 | 0.69 | 0.014 | 0.021 | 0.029 |
| HE | 2.10 | 2.40 | 2.64 | 0.083 | 0.094 | 0.104 |
| θ | 0° | --- | 10° | 0° | --- | 10° |

STYLE 21:

- PIN 1. GATE
- SOURCE
- DRAIN

SOLDERING FOOTPRINT



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